

PCM270xEVM-U

This user's guide contains information on the setup, operation, and construction of the PCM270xEVM-U, an evaluation module (EVM) for digital-to-analog converters (DACs) PCM2704 and PCM2705.

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1 Description

The PCM270xEVM-U is an evaluation board for the USB interface DACs PCM2704 (DEM-PCM2704) and PCM2705 (DEM-PCM2705).

A USB connector is mounted on the PCM270xEVM-U. This connector allows a customer to evaluate DAC performance by connecting a USB interface to it.

By the use of jumper settings on the board, the PCM270xEVM-U can be operated either from USB bus power or from an external 5-V power supply.

The PCM270xEVM-U outputs a stereo audio signal for headphones at stereo minijack CN2 (PD = 12 mW at $R_L = 32 \Omega$), and an S/PDIF digital interface output at optical ToslinkTM connector U4.

The PCM270xEVM-U is fully compliant with the USB 1.1 specification with full-speed transceiver format.

1.1 Related Documentation From Texas Instruments

PCM2704, PCM2705, PCM2706, PCM2707 Stereo Audio DAC With USB Interface, Single-Ended Headphone Output and S/PDIF Output data sheet (SLES081)

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1.2 Block Diagram

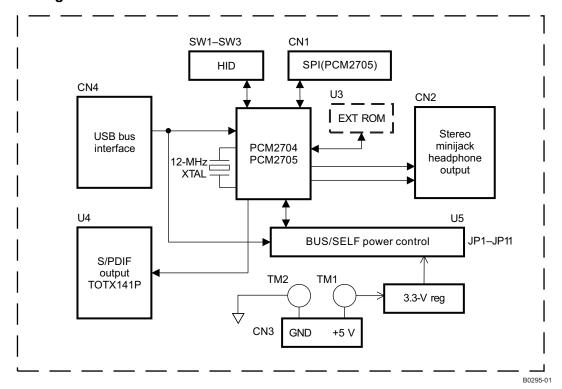


Figure 1. PCM270xEVM-U Block Diagram

1.3 Basic Operating Connections

1.3.1 Universal Serial Bus (USB)

A USB interface is connected to USB connector CN4.

1.3.2 Stereo Headphone Output

A stereo headphone plug is connected to stereo minijack audio output connector CN2.

1.3.3 Bus-Power/Self-Power Selection

Operation in the bus-powered or self-powered mode is user selectable, chosen by jumper plug settings on the board. The default setting is self-powered operation.

Bus-Powered

JP1, (JP7): Shorting plug of jumper JP1 must be connected. (JP7 can be removed if the

application draws less than 100 mA.)

JP2–JP6, JP8: Shorting plugs of jumpers JP2–JP6, JP8 must be removed.

JP9, JP10, JP11: Shorting plugs of jumpers JP9, JP10, and JP11 must be connected on the BUS

side.

CN3 or TM1, TM2 external power supply:

External 5-V power supply must not be connected.



www.ti.com Description

Self-Powered (default setting)

JP1: Shorting plug of jumper JP1 must be removed.

JP2-JP8: Shorting plugs of jumpers JP2-JP8 must be connected.

JP9, JP10, JP11: Shorting plugs of jumpers JP9, JP10, and JP11 must be connected on the SELF

side.

CN3 or TM1, TM2 external power supply:

External power supply must be connected either to CN3 or to TM1 and TM2. ($V_{CC} = 4.5 \text{ V}$ to 10 V. $I_{CC} = 30 \text{ mA}$ typical, 70 mA maximum.) A 3.3-V regulator IC is mounted to provide a 3.3-V power supply for PCM2704/2705 and logic circuitry on the board from the external power supply.

In the case of self-powered operation, device is enabled when the USB interface is connected and HOST is set to High.

1.3.4 SPI Interface (PCM2705)

An SPI interface (MS, MC, MD) for operational control of the PCM2705 can be connected at CN1.

1.3.5 Suspend

Suspend status is indicated at the SSPND pin of CN1.

1.3.6 S/PDIF Output

USB audio data input to the PCM2704/2705 is output in S/PDIF format. This electrical output is sent to U4, which converts the S/PDIF signal into light for optical transmission.



2 Schematic, BOM, and Printed-Circuit Board

This chapter presents the PCM270xEVM-U printed-circuit board and schematic.

PCM270xEVM-U Schematic 2.1

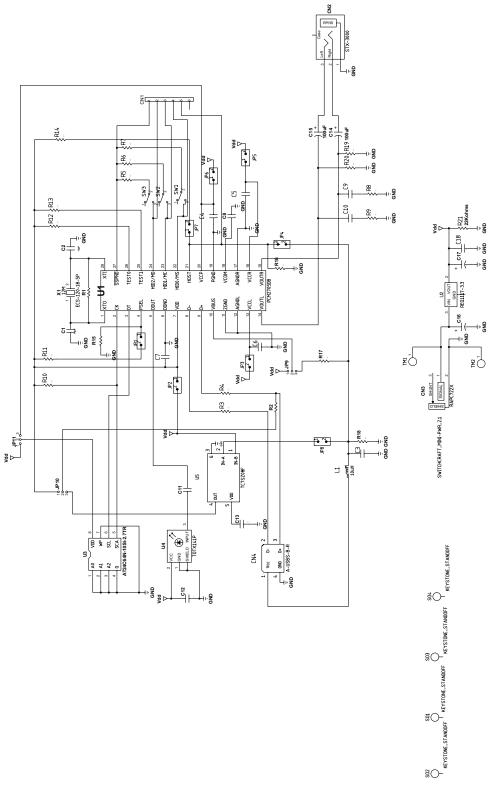


Figure 2. PCM270xEVM-U Circuit Diagram



2.2 PCM270xEVM-U Parts List (BOM)

Table 1. Bill of Materials

| ltem | QTY | MFG | MFG Part# | REF DES | Description | Value or Function |
|------|-----|---------------------|----------------------------|--|--------------------|---|
| | REF | - | PCM2704/2705 EVMA | - | ASSEMBLY | - |
| | REF | - | PCM2704/2705 EVMA | - | SCHEMATIC | - |
| | 1 | One Source Group | PCM2704/2705 EVMA | - | FABRICATION | - |
| | REF | _ | PCM2704/2705 EVMA | - | ARTWORK | - |
| 1 | 4 | | 2031 | SO1, SO2, SO3, SO4 | | STANDOFF,4-40,1.0INx3/16IN,ALUM RND F-F |
| 2 | 3 | | 26630301RP2 | JP9, JP10, JP11 | | HEADER 3 PIN, PCB 2.0MM ROHS |
| 3 | 1 | | 26630601RP2 | CN1 | | HEADER 6 PIN, PCB 2.0MM ROHS |
| 4 | 1 | | RAPC722X | CN3 | | JACK MINI-PWR THRU-RA 2,1ID/5.5OD 5A ROHS |
| 5 | 1 | | STX-3000 | CN2 | | JACK,MINI-STEREO,ROHS |
| 6 | 1 | | TC7SZ08F | U5 | | 2-Input AND Gate |
| 7 | 1 | | TOTX141P | U4 | | TOSLINK TRANSMITTER 3.3V 15MB SHUTTER ROHS |
| 8 | 6 | | GRM185R61A105KE36D | C3, C4, C5, C6, C7, C12 | 603 | CAP SMD0603 CERM 1.0UFD 10V 10% X5R ROHS |
| 9 | 1 | | GRM21BR71A106KE51L- VSA | C8 | 805 | CAP SMD0805 CERM 10UFD 10V10% X7R ROHS |
| 10 | 1 | | 3750-0 | TM2 | Black | BINDING POST, BLACK 60V/15A GOLD ROHS |
| 11 | 1 | PANASONIC | ECQ-B1H104JF | C18 | CAP,RAD,POLY | CAP,THU,POLYES-FILM,0.1µF,50V,5%,85C |
| 12 | 2 | MURATA | GRM39X7R223K16V | C9, C10 | CAP,SMT,0603 | CAPACITOR,SMT,0603,CERAMIC,16V,10%,.022µ F |
| 13 | 2 | MURATA | GRM40COG150J50V | C1, C2 | CAP,SMT,0805 | 50V,±5%,15pF |
| 14 | 2 | MURATA | GRM40X7R103K50V | C11, C13 | CAP,SMT,0805 | 50V,10%,.010μF |
| 15 | 2 | PANASONIC | EEVFC0J101P | C14, C15 | CAPACITOR,SMT,ELEC | CAPACITOR,SMT,ELEC,100uF,6.3V,20%, -40~105°C |
| 16 | 1 | ASSMANN ELEC | A-USBS-B-R | CN4 | CONNECTOR,THU,4P | CONNECTOR,THU,4P,USB RECEPTACLE,TYPE B, PCB MOUNT |
| 17 | 1 | ECS | ECS-120-18-5P | X1 | CRYSTAL,SMT,2P | XTL,SMT,12.000MHz,18pF,Fund,50ppm,-10~70°C |
| 18 | 3 | | G12AP-RO | SW1, SW2, SW3 | G12AP | SWITCH THRU SPDT STRAIGHT ULTRA MINIATURE ROHS |
| 19 | 8 | SAMTEC | TSW-101-07-G-D | JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8 | HEADER,THU | HEADER,THU,2P,2X1,MALE,DUAL ROW,100LS,100TL |
| 20 | 1 | ATMEL | AT24C64N-10SI-2.7TR | U3 | IC,SMT,8P | 2 WIRE SERIAL EEPROM |
| 21 | 1 | PANASONIC | ELJFA100KJ/F | L1 | INDUCTOR,SMT | 10.0µH |
| 22 | 2 | | ECA1CM100 | C16, C17 | М | CAP ALUM ELEC M RADIAL 10UFD 16V 20% ROHS |
| 23 | 2 | VISHAY | CRCW08051002F | R19, R20 | RES,SMT,0805 | RESISTOR,SMT,0805,THICK FILM,1%,1/8W,10.0K |
| 24 | 3 | VISHAY | CRCW08051004F | R1, R15, R16 | RES,SMT,0805 | RESISTER,SMT,0805,THICK FILM,1%,1/8W,1.00M |
| 25 | 1 | VISHAY | CRCW080510R0F | R17 | RES,SMT,0805 | RESISTER,SMT,0805,THICK FILM,1%,1/8W,10.0 Ω |
| 26 | 9 | VISHAY | CRCW08051501F | R2, R5, R6, R7, R10, R11, R12, R13, R14 | RES,SMT,0805 | RESISTER,SMT,0805,THICK FILM,1%,1/8W,1.50K |
| 27 | 1 | PANASONIC | ERJ-6GEYJ106V | R18 | RES,SMT,0805 | RESISTOR,SMT,0805,THICK FILM,10M,5%,1/8W |
| 28 | 2 | PANASONIC | ERJ-6GEYJ160V | R8, R9 | RES,SMT,0805 | RESISTOR,SMT,0805,THICK FILM,5%,1/8W,16 |
| 29 | 2 | PANASONIC | ERJ-6GEYJ270V | R3, R4 | RES,SMT,0805 | RESISTOR,SMT,0805,THICK FILM,5%,1/8W,27 |
| 30 | 1 | PANASONIC | ERA-6YEB223V | R21 | RES,SMT,2P | RESISTOR,SMT,0805,22K,0.1%,1/10W,25ppm |
| 31 | 1 | | 3750-2 | TM1 | Red | BINDING POST, RED 60V/15A GOLD ROHS |
| 32 | 1 | | REG1117-3.3 | U2 | SOT223-DCY | VOLT REG 3.3V 800mA SOT223-DCY ROHS |
| 33 | 1 | | PCM2705DB | U1 | SSOP28-DB | STEREO AUDIO DAC W/USB SE HEADPHONE/SPDIF OUT SSOP28-DB ROHS |

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2.3 PCM270xEVM-U Printed-Circuit Board

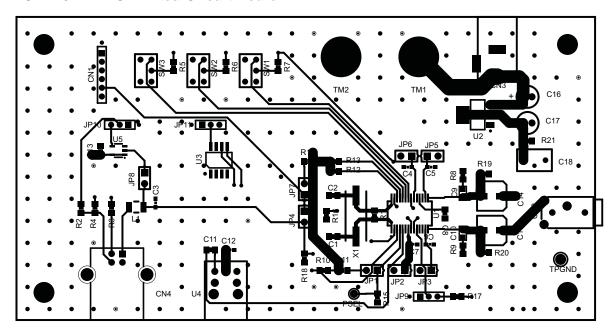


Figure 3. PCM270xEVM-U Silkscreen

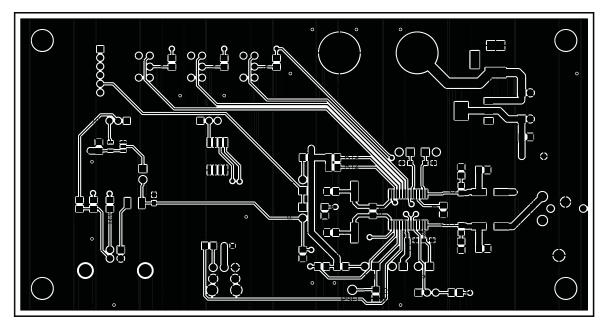


Figure 4. PCM270xEVM-U—Top View



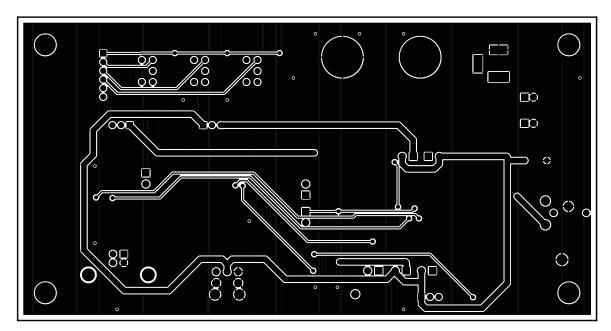


Figure 5. PCM270xEVM-U—Bottom View

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EVM Warnings and Restrictions

It is important to operate this EVM within the input voltage range of 5 V and the output voltage range of 5 V .

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 55°C. The EVM is designed to operate properly with certain components above 55°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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